APPROVAL SHEET



CUSTOMER:	
DESCRIPTION:	SMD8×3.8 32.768KHz Quartz Crystal Resonator
MANUFACTURER PART NO.:	FTX32.768K12.5SM8-20C
CUSTOMER PART NO:	
USED IN MODEL:	
REVISION	A1

	承	认	AP	PROVAL
工程部	먇	质部		采购部
TECHNOLOGY DEPT.	QUAL	JTY DEPT.]	PURCHASING DEPT.

Date: September 18, 2017

Rev	Revise page	Revise contents	<u>Date</u>	Ref.No.	<u>Reviser</u>
A1	ALL	Initial released		N/A	DavidJiang

1. QUARTZ CRYSTAL UNIT SPECIFICATION

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1.1 Frequency: 32.768KHz

1.2 Holder type: SMD8×3.8mm

1.3 Frequency tolerance: ±20ppm at 25°C

1.4 Equivalent resistance: 50Kohms Max

1.5 Operating temperature range: -40°C To +85°C

1.6 Storage temperature range: -55°C To +125°C

1.7 Temperature Coefficient: $-0.04 \times 10^{-6} / ^{\circ} \text{C}^2 \text{ max}$

1.8 Turn-over temperature:: $+25^{\circ}C \pm 5^{\circ}C$

1.9 Loading capacitance (CL): 12.5pF

1.10 Drive level: 1.0uW max

1.11 Shunt Capacitance: 1.4pF Typical

1.12 Motional Capacitance: 2.8fF Typical

1.13 Insulation resistance: More than 500M ohms

1.14 Aging: Less than ±3 ppm/Year

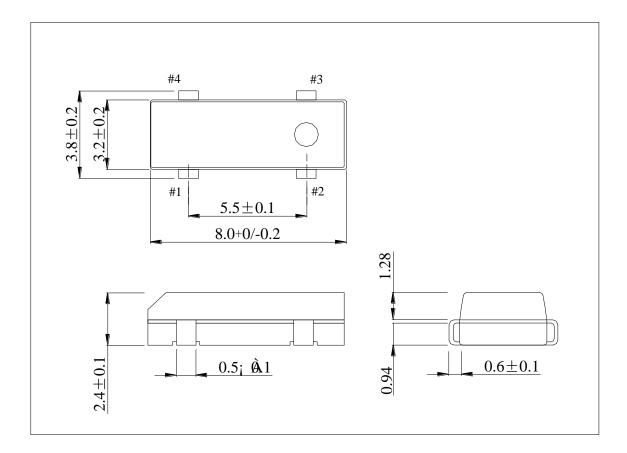
Ta=+25°C±3°C, first year

1.15 Dimensions and marking: Refer to page.3

1.16 Emboss carrier tape & reel: Refer to page.4

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2. DIMENSIONS (Unit: mm)

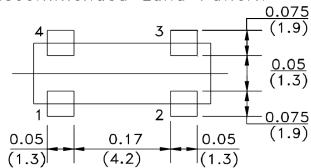


X Do not connect #2 and #3 to external device.

■ Internal Connections

⟨Top View⟩ #4 #3

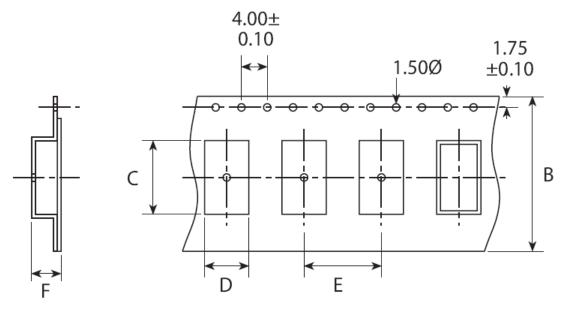
Recommended Land Pattern



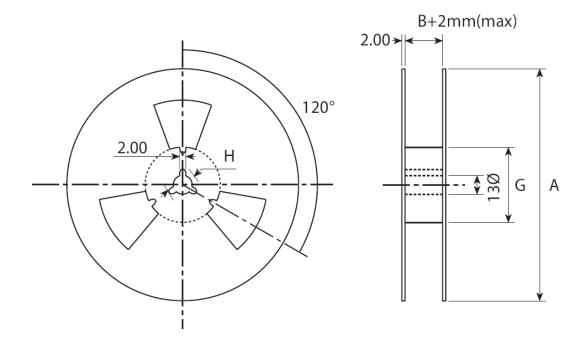
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3 CARRIER TAPE & REEL

a.) Dimensions of Carrier Tape (Unit: mm)



b.) Dimensions of Reel (Unit: mm)



	A	В	С	D	E	F	G
SMD8×3.8	330±2.0	16.0±0.3	8.5 ± 0.2	4.1 ± 0.2	8.0	2.7 ± 0.1	100 ± 1.0

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a.) Storage condition

Temperature: -55deg.C To +125deg.C

Relative Humidity: 80% Max.

b.) Standard packing quantity

2,000PCS / REEL

c.) Material of the tape

Tape	Material
Carrier tape	A- PET
Top tape	Polyester

- d.) Label contents
 - .The type of product
 - .Our specification No.
 - .Your Part No.
 - .Lot No.
 - .Nominal Frequency
 - .Quantity
 - .Our Company Name

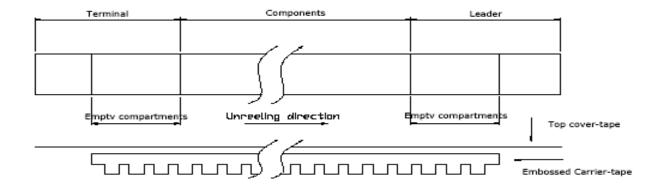
Sticks label for every reel.

PART NUMBER Lot. NO: HOLDER TYPE FREQUENCY REMAKS QUANTITY	FRONTER ELECT	RONICS CO.,LTD.
Lot. NO: HOLDER TYPE FREQUENCY	QUANTITY	
Lot. NO: HOLDER TYPE	REMAKS	
Lot. NO:	FREQUENCY	
	HOLDER TYPE	
PART NUMBER	Lot. NO:	
	PART NUMBER	

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e.) Taping dimension

Cover-tape Leader Carrier-tape	Cover-tape	The length of cover-tape in the leader is more than 400 mm including empty embossed area.
	After all products were packaged, must remain more than twenty pieces or 400 mm empty area, which should be sealed by cover-tape.	
Cover-tape		The tip of cover-tape shall be fixed temporary by paper tape and roll around the core of reel one round.
Terminal •	Carrier-tape	The empty embossed area which are sealed by top cover-tape must remain more the 40 mm.



f.) Joint of tape

The carrier-tape and top cover-tape should not be jointed.

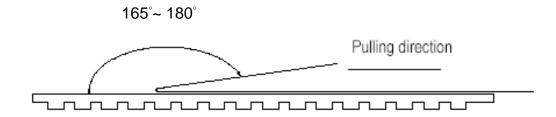
g.) Release strength of cover tape

It has to between 0.1N to 0.7N under following condition.

Pulling direction 165° to 180°

Speed 300mm/min.

Otherwise unless specified.



Other standards shall be based on JIS C 0806-1990.

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4. Mechanical Endurance: Provided that measurement shall be carried out afterletting it alone in the room temperature for 1 hour.

Item	Conditions	Specifications
Shock (Destructive)	from the height of 75 cm onto hard wooden broad of	
Vibration (Destructive)	Cvcle time: 1~2min(10-55-10Hz)	
Terminal Strength (Destructive)	Pulling: body of resonator shall be fixed, and 0.5kg of tension weight shall be supplied gradually to axial direction of lead terminals for 30 seconds Bending: body of resonator shall be fixed, And 90°Cbending at a distance of 2.5±0.5 mm from crystal main body shall be given being supplied 250g tension weight. after that, lead terminals shall be straightened gradually. Then, the same bending and straightening shall be supplied to the opposite direction in the same axial.	The lead shall not be broken, measured Values shall meet Table 1.
Solder Heating (Destructive)	Each lead terminals shall be dipped into the solder melted tank at 300±10°C for 3±0.5 resonator ,and at 260±10°C for 10 ± 1 seconds by the same way.	No visible damage, and measured Values shall meet Table 1.
Solder ability (Destructive)	Dip the lead in liquid solder for 2± 0.5 seconds, at 230±5°C and 2.0mm from the root, after this dipping, 90% min. of dipped parts shall be covered with solder.	No visible damage, and measured Values shall meet Table 1.
Leakage (non-destructive)	The resonator is to be soaked in the alcohol and enforced with the pressure of 25N/cm² for 5 minutes Next, the resonator shall be tested after being taken out and dried with a dryer.	The Ir between the wire and the shell must be more than $500M\Omega$.

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5. Environmental Endurance: Provided that measurement shall be carried out afterletting it alone in the room temperature for 2 hours.

	Item	Conditions	Specifications
5.1	Humidity	Should be satisfied after letting it alone at +60°C±2°C in humidity of 93% ± 2% for 24 hours.	No visible damage, measured Values shall meet Table1.
5.2	Storage in Low Temperature	Should be satisfied after letting it alone at -30°C±2°for 72 hours.	No visible damage, measured Values shall meet Table1
5.3	Storage in High Temperature	Should be satisfied after letting it alone at +70°C±2°C for 72 hours.	No visible damage, measured Values shall meet Table1
5.4	Temperature Cycle	Should be satisfied after supplying the following temperature cycle (5 cycles). (Refer to Fig-4). Temperature shift from low to high, high to low shall be done in 1°C/min.	No visible damage, measured Values shall meet Table1

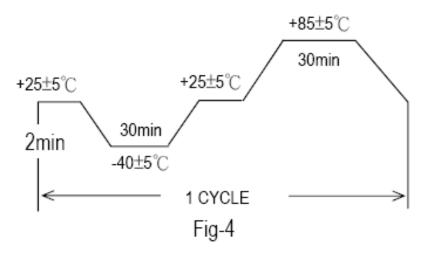
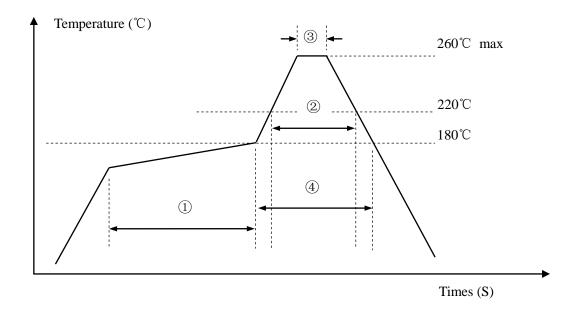


Table 1

Test Item	Specification	Note
Frequency change (△f/fo)	\pm 5ppm	Reference to the initial value
C.I. (△R)	15%	Reference to the initial value

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6. Reflow



	1	Preheat	150~180℃	100sec. max
Pb free reflow	2	Primary heat	220℃	35sec. max
В	3	Peak	260℃	10sec. max
	4	Reflow	180~180℃	60~90 sec.

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